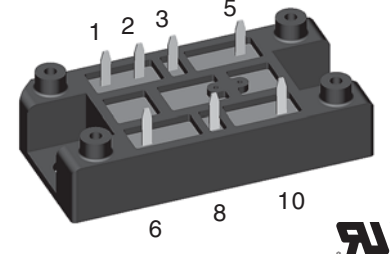
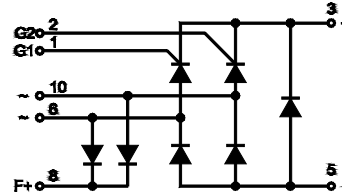


# Half Controlled Single Phase Rectifier Bridge

Including Freewheeling Diode and Field Diodes

$V_{RRM} = 800-1600\text{ V}$   
 $I_{dAVM} = 40\text{ A}$

$V_{RSM}$ $V_{DSM}$ V	$V_{RRM}$ $V_{DRM}$ V	Type
900	800	VHFD 37-08io1
1300	1200	VHFD 37-12io1
1700	1600	VHFD 37-16io1



## Bridge and Freewheeling Diode

Symbol	Conditions	Maximum Ratings
$I_{dAV}$	$T_H = 85^\circ\text{C}$ , module	36 A
$I_{dAVM}^*$	module	40 A
$I_{FRMS}, I_{TRMS}$	per leg	31 A
$I_{FSM}, I_{TSM}$	$T_{VJ} = 45^\circ\text{C}$ ; $V_R = 0\text{ V}$	$t = 10\text{ ms}$ (50 Hz), sine 320 A $t = 8.3\text{ ms}$ (60 Hz), sine 350 A
	$T_{VJ} = T_{VJM}$ $V_R = 0\text{ V}$	$t = 10\text{ ms}$ (50 Hz), sine 280 A $t = 8.3\text{ ms}$ (60 Hz), sine 310 A
$I^2t$	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0\text{ V}$	$t = 10\text{ ms}$ (50 Hz), sine 500 A <sup>2</sup> s $t = 8.3\text{ ms}$ (60 Hz), sine 520 A <sup>2</sup> s
	$T_{VJ} = T_{VJM}$ $V_R = 0\text{ V}$	$t = 10\text{ ms}$ (50 Hz), sine 390 A <sup>2</sup> s $t = 8.3\text{ ms}$ (60 Hz), sine 400 A <sup>2</sup> s
$(di/dt)_{cr}$	$T_{VJ} = 125^\circ\text{C}$ $f = 50\text{ Hz}$ , $t_p = 200\text{ }\mu\text{s}$ $V_D = 2/3 V_{DRM}$ $I_G = 0.3\text{ A}$ , $di_G/dt = 0.3\text{ A}/\mu\text{s}$	repetitive, $I_T = 50\text{ A}$ 150 A/ $\mu\text{s}$ non repetitive, $I_T = 0.5 I_{dAV}$ 500 A/ $\mu\text{s}$
	$T_{VJ} = T_{(VJ)m}$ ; $V_{DR} = 2/3 V_{DRM}$ $R_{GK} = \infty$ ; method 1 (linear voltage rise)	1000 V/ $\mu\text{s}$
$V_{RGM}$		10 V
$P_{GM}$	$T_{VJ} = T_{VJM}$ $I_T = 0.5 I_{dAVM}$	$t_p = 30\text{ }\mu\text{s}$ $\leq 10\text{ W}$ $t_p = 500\text{ }\mu\text{s}$ $\leq 5\text{ W}$ $t_p = 10\text{ ms}$ $\leq 1\text{ W}$
		0.5 W
		$P_{GAVM}$
$T_{VJ}$		-40...+125 °C
$T_{VJM}$		125 °C
$T_{stg}$		-40...+125 °C
$V_{ISOL}$	50/60 Hz, RMS	$t = 1\text{ min}$ 3000 V~ $t = 1\text{ s}$ 3600 V~
	$I_{ISOL} \leq 1\text{ mA}$	
$d_s$	Creep distance on surface	12.7 mm
$d_A$	Strike distance in air	9.4 mm
$a$	Max. allowable acceleration	50 m/s <sup>2</sup>
$M_d$	Mounting torque (M5) (10-32 UNF)	2-2.5 Nm
		18-22 lb.in.
Weight		35 g

### Features

- Package with DCB ceramic base plate
- Isolation voltage 3600 V~
- Planar passivated chips
- Blocking voltage up to 1600 V
- Low forward voltage drop
- Leads suitable for PC board soldering
- UL registered E 72873

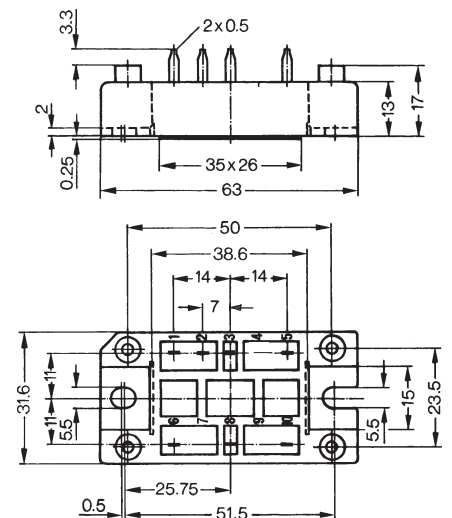
### Applications

- Supply for DC power equipment
- DC motor control

### Advantages

- Easy to mount with two screws
- Space and weight savings
- Improved temperature and power cycling

### Dimensions in mm (1 mm = 0.0394")



Symbol	Conditions	Characteristic Values
$I_R, I_D$	$V_R = V_{RRM}; V_D = V_{DRM}$ $T_{VJ} = T_{VJM}$ $T_{VJ} = 25^\circ\text{C}$	$\leq 5$ mA $\leq 0.3$ mA
$V_T, V_F$	$I_T, I_F = 45$ A; $T_{VJ} = 25^\circ\text{C}$	$\leq 1.45$ V
$V_{T0}$	For power-loss calculations only ( $T_{VJ} = 125^\circ\text{C}$ )	0.85 V
$r_T$		13 m $\Omega$
$V_{GT}$	$V_D = 6$ V; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	$\leq 1.0$ V $\leq 1.2$ V
$I_{GT}$	$V_D = 6$ V; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	$\leq 65$ mA $\leq 80$ mA $\leq 50$ mA
$V_{GD}$	$T_{VJ} = T_{VJM};$ $V_D = 2/3 V_{DRM}$	$\leq 0.2$ V
$I_{GD}$	$T_{VJ} = T_{VJM};$ $V_D = 2/3 V_{DRM}$	$\leq 5$ mA
$I_L$	$I_G = 0.3$ A; $t_G = 30$ $\mu\text{s}$ ; $di_G/dt = 0.3$ A/ $\mu\text{s}$ ; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	$\leq 150$ mA $\leq 200$ mA $\leq 100$ mA
$I_H$	$T_{VJ} = 25^\circ\text{C}; V_D = 6$ V; $R_{GK} = \infty$	$\leq 100$ mA
$t_{gd}$	$T_{VJ} = 25^\circ\text{C}; V_D = 1/2 V_{DRM}$ $I_G = 0.3$ A; $di_G/dt = 0.3$ A/ $\mu\text{s}$	$\leq 2$ $\mu\text{s}$
$t_q$	$T_{VJ} = 125^\circ\text{C}; I_T = 15$ A, $t_p = 300$ $\mu\text{s}$ , $V_R = 100$ V	typ. 150 $\mu\text{s}$
$Q_f$	$di/dt = -10$ A/ $\mu\text{s}$ , $dv/dt = 20$ V/ $\mu\text{s}$ , $V_D = 2/3 V_{DRM}$	75 $\mu\text{C}$
$R_{thJC}$	per thyristor (diode); DC current	1.2 K/W
	per module	0.3 K/W
$R_{thJH}$	per thyristor (diode); DC current	1.55 K/W
	per module	0.39 K/W

## Field Diodes

Symbol	Conditions	Maximum Ratings
$I_{FAV}$	$T_H = 85^\circ\text{C}$ , per Diode	4 A
$I_{FAVM}$	per diode	4 A
$I_{FRMS}$	per diode	6 A
$I_{FSM}$	$T_{VJ} = 45^\circ\text{C};$ $V_R = 0$ V $t = 10$ ms (50 Hz), sine $t = 8.3$ ms (60 Hz), sine	100 A 110 A
	$T_{VJ} = T_{VJM}$ $V_R = 0$ V $t = 10$ ms (50 Hz), sine $t = 8.3$ ms (60 Hz), sine	85 A 94 A
$I^2t$	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0$ V $t = 10$ ms (50 Hz), sine $t = 8.3$ ms (60 Hz), sine	50 A <sup>2</sup> s 50 A <sup>2</sup> s
	$T_{VJ} = T_{VJM}$ $V_R = 0$ V $t = 10$ ms (50 Hz), sine $t = 8.3$ ms (60 Hz), sine	36 A <sup>2</sup> s 37 A <sup>2</sup> s
$I_R$	$V_R = V_{RRM}$ $T_{VJ} = T_{VJM}$ $T_{VJ} = 25^\circ\text{C}$	1 mA 0.15 mA
$V_F$	$I_F = 21$ A; $T_{VJ} = 25^\circ\text{C}$	1.83 V
$V_{T0}$	For power-loss calculations only ( $T_{VJ} = 125^\circ\text{C}$ )	0.9 V
$r_T$		50 m $\Omega$
$R_{thJC}$	per diode; DC current	4.4 K/W
$R_{thJH}$	per diode; DC current	5.2 K/W

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.  
\* for resistive load

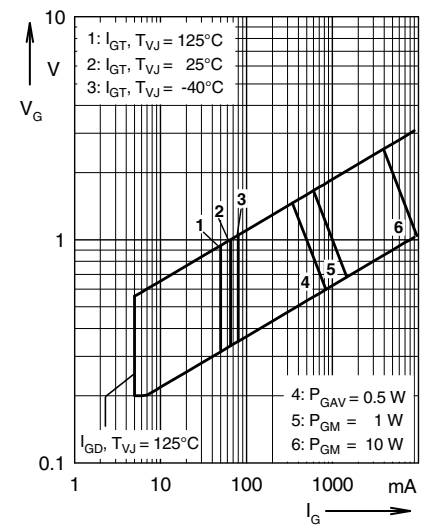


Fig. 1 Gate trigger range

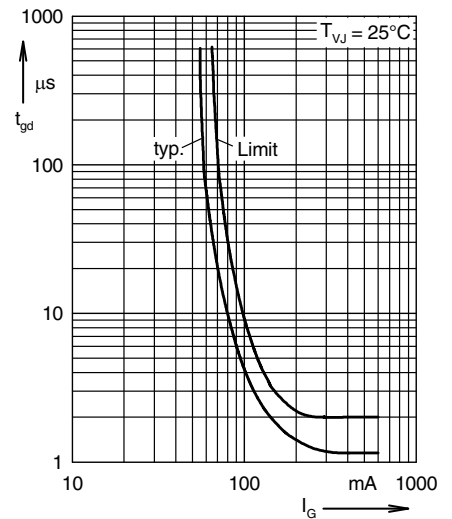


Fig. 2 Gate controlled delay time  $t_{gd}$

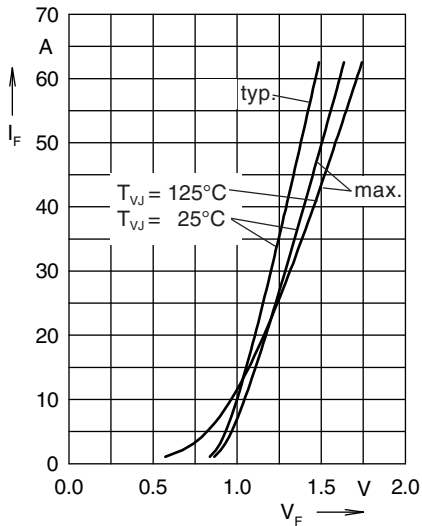


Fig. 3 Forward current vs. voltage drop per diode

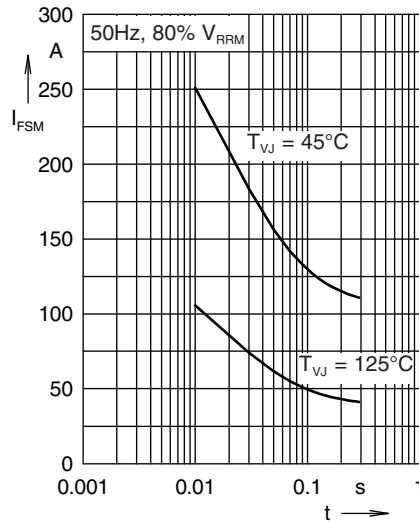


Fig. 4 Surge overload current

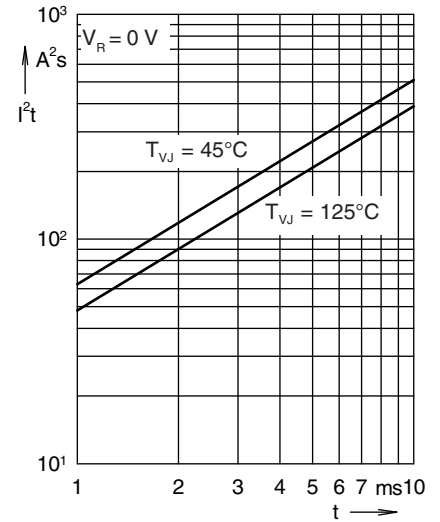


Fig. 5  $I^2t$  versus time per diode

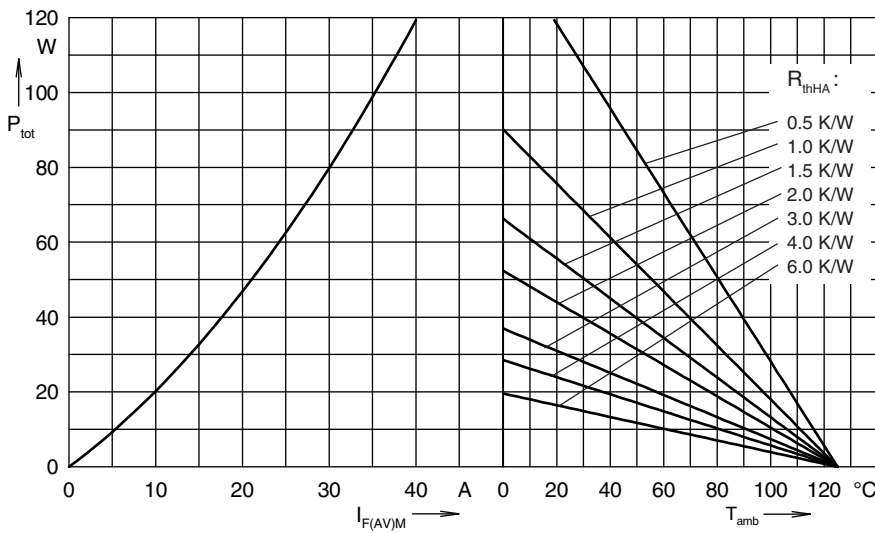


Fig. 6 Power dissipation vs. direct output current and ambient temperature

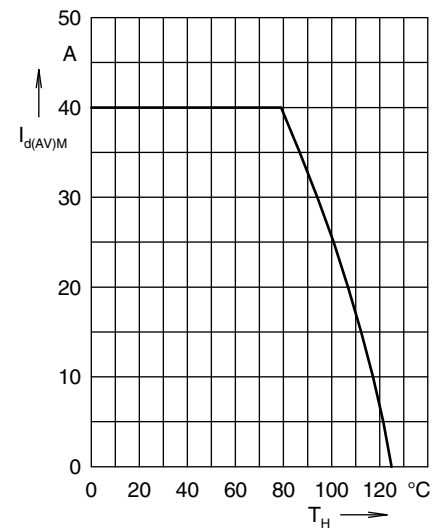


Fig. 7 Max. forward current vs. heatsink temperature

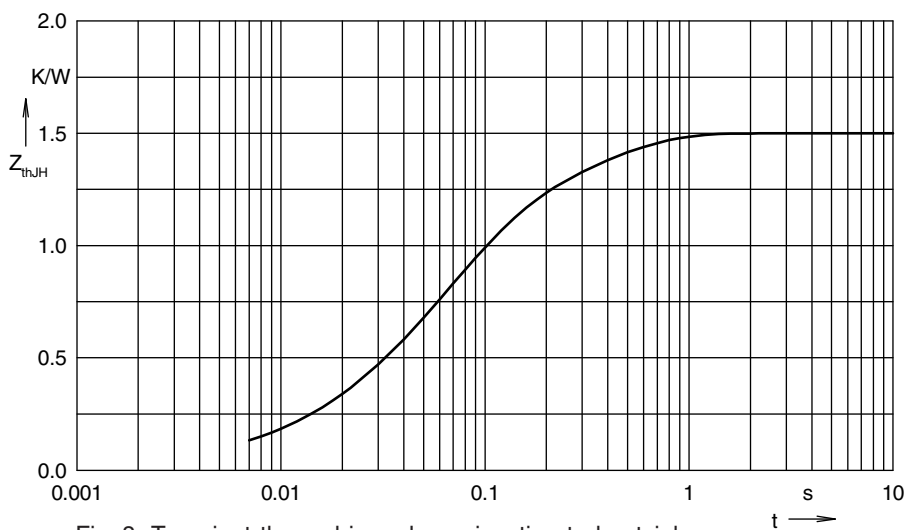


Fig. 8 Transient thermal impedance junction to heatsink

Constants for  $Z_{thJH}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.005	0.008
2	0.2	0.05
3	0.875	0.06
4	0.47	0.25